

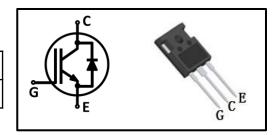
#### **Features**

- Easy parallel switching capability due to positive temperature coefficient in V<sub>CEsat</sub>
- Low V<sub>CEsat</sub>, fast switching
- High ruggedness, good thermal stability
- Very tight parameter distribution

Туре	Marking	Package Code
MPBW50N65ED	MP50N65ED	TO-247-3

## **Applications**

- **■** UPS
- PFC
- **■** PTC Heater
- **■** Climate Compressor



#### Maximum Rated Values 1

Parameter	Symbol	Value	Unit		
Collector-emitter voltage	V <sub>CE</sub>	650	V		
DC collector current <sup>2</sup>					
T <sub>C</sub> =25°C		80			
T <sub>C</sub> =100°C	- I <sub>C</sub>	50			
Pulsed collector current <sup>3</sup>	I <sub>Cpuls</sub>	200	A		
Diode forward current <sup>2</sup>					
T <sub>C</sub> =25°C		80			
T <sub>C</sub> =100°C	- I <sub>F</sub>	50			
Diode pulsed current <sup>3</sup>	I <sub>Fpuls</sub>	200			
Gate-emitter voltage	V <sub>GE</sub>	±20	V		
Transient Gate-emitter voltage (t <sub>p</sub> ≤10us)		±30	V		
Power dissipation					
T <sub>C</sub> =25°C	D	300	W		
T <sub>C</sub> =100°C	P <sub>tot</sub>	150			
Operating junction temperature	T <sub>j</sub>	-55~175	°C		
Storage temperature	T <sub>stg</sub>	-55~150			

<sup>1:</sup>Reference standard: JESD-022 2: limited by Tjmax 3: Tp limited by Tjmax ;



## **Thermal Characteristics**

Parameter	Symbol	Min	Тур	Max	Unit
IGBT thermal resistance, junction-case	R <sub>thJC</sub>	ı	1	0.5	
Diode thermal resistance, junction-case	R <sub>thJCD</sub>	ı	1	0.65	K/W
Thermal Resistance, junction-ambient	R <sub>thJA</sub>	ı	-	40	

# Electrical Characteristics (at Tj=25°C, unless otherwise specified) Static Characteristics

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter breakdown voltage	V <sub>(BR)CES</sub>	V <sub>GE</sub> =0V, I <sub>C</sub> =0.25mA	650	-	-	
Collector-emitter		V <sub>GE</sub> =15V, I <sub>C</sub> =50A T <sub>j</sub> =25°C	ı	1.60	1.90	
saturation voltage	V <sub>CE(sat)</sub>	T <sub>j</sub> =125°C	1	1.72	1	
		T <sub>j</sub> =150°C	-	1.80	-	V
Diode forward voltage	V <sub>F</sub>	V <sub>GE</sub> =0V, I <sub>F</sub> =50A T <sub>j</sub> =25°C	1	1.95	2.25	
		T <sub>j</sub> =125°C	-	1.87	-	
		T <sub>j</sub> =150°C	1	1.82	1	
G-E threshold voltage	$V_{GE(th)}$	$I_C=1$ mA, $V_{CE}=V_{GE}$	4.5	5.5	6.5	
C-E leakage current	I <sub>CES</sub>	$V_{CE}$ =650V, $V_{GE}$ =0V $T_{j}$ =25°C	1	ı	0.01	mA
		T <sub>j</sub> =150°C	-	-	1.0	
G-E leakage current	I <sub>GES</sub>	$V_{CE}=0V$ , $V_{GE}=20V$	ı	-	250	nA
Transconductance	g <sub>FS</sub>	V <sub>CE</sub> =20V, I <sub>C</sub> =50A	-	21	-	S

## **Dynamic Characteristics**

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Input capacitance	C <sub>iss</sub>	V 25V	-	5810	-	
Output capacitance	C <sub>oss</sub>	V <sub>CE</sub> =25V, V <sub>GE</sub> =0V, f=1MHz	-	130	-	pF
Reverse transfer capacitance	C <sub>rss</sub>		-	65	-	
Gate charge	$Q_{G}$	V <sub>CC</sub> =300V, I <sub>C</sub> =50A, V <sub>GE</sub> =15V	-	230	-	nC



# **IGBT Switching Characteristics**

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Turn-on delay time	t <sub>d(on)</sub>		-	107	-	
Rise time	t <sub>r</sub>	T <sub>j</sub> =25℃,	-	62	-	
Turn-off delay time	t <sub>d(off)</sub>	V <sub>CC</sub> =400V,	-	265	1	ns
Fall time	t <sub>f</sub>	I <sub>C</sub> =50A, V <sub>GE</sub> =0/15V,	-	48	-	
Turn-on energy	E <sub>on</sub>	$R_{G}=10\Omega$ ,	-	0.90	-	
Turn-off energy	E <sub>off</sub>	Inductive load	-	1.12	-	mJ
Total switching energy	E <sub>ts</sub>		-	2.02	-	
Turn-on delay time	t <sub>d(on)</sub>		-	100	-	
Rise time	t <sub>r</sub>	T <sub>j</sub> =150°C,	-	62		200
Turn-off delay time	t <sub>d(off)</sub>	V <sub>CC</sub> =400V,	-	335	-	ns
Fall time	t <sub>f</sub>	I <sub>C</sub> =50A, V <sub>GE</sub> =0/15V, R <sub>G</sub> =10Ω, Inductive load	-	50	1	
Turn-on energy	E <sub>on</sub>		-	1.35	1	
Turn-off energy	E <sub>off</sub>		-	1.40	-	mJ
Total switching energy	E <sub>ts</sub>		-	2.75	-	

## **Diode Characteristics**

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Diode reverse recovery time	t <sub>rr</sub>	T <sub>i</sub> =25°C,	-	57	-	ns
Diode reverse recovery charge	Q <sub>rr</sub>	$V_{R}$ =400V, $I_{F}$ =50A,	-	0.39	-	μC
Diode peak reverse recovery current	I <sub>rrm</sub>	di <sub>F</sub> /dt=640A/µs	-	10.6	-	Α
Diode reverse recovery time	t <sub>rr</sub>	T <sub>i</sub> =150°C,	-	92.8	-	ns
Diode reverse recovery charge	Q <sub>rr</sub>	V <sub>R</sub> =400V, I <sub>F</sub> =50A,	-	1.48	-	μC
Diode peak reverse recovery current	I <sub>rrm</sub>	di <sub>F</sub> /dt=640A/µs	-	24	-	А



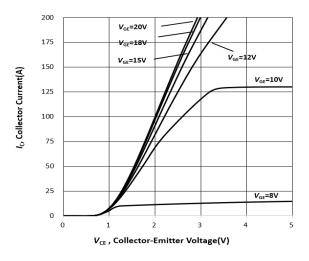


Figure 1. Typical output characteristic  $(T_i = 25^{\circ}\text{C})$ 

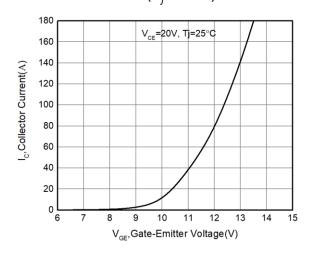


Figure 3. Typical transfer characteristic  $(T_i = 25^{\circ}\text{C})$ 

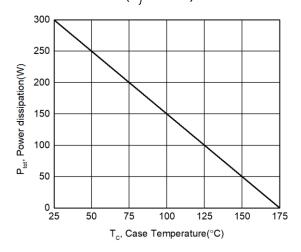


Figure 5. Power dissipation as a function of case temperature  $(T \le 175^{\circ}\text{C})$ 

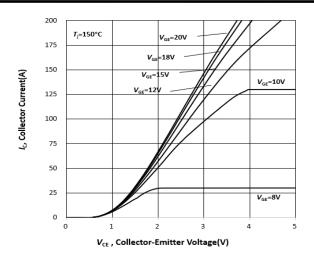


Figure 2. Typical output characteristic  $(T_i = 150^{\circ}\text{C})$ 

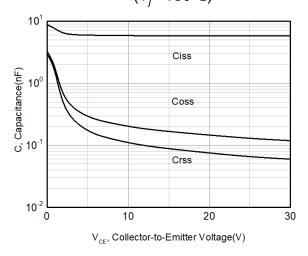


Figure 4. Capacitance characteristic  $(V_{GF}=0V, f=1MHz)$ 

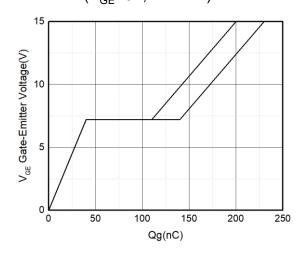


Figure 6. Typical gate charge ( $I_C$ =50A)



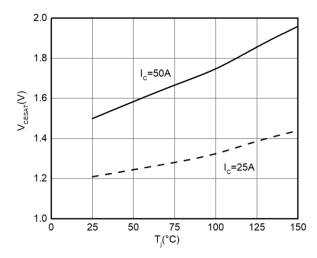


Figure 7.  $V_{CESAT}$  as a function of junction temperature ( $V_{GE}$ =15V)

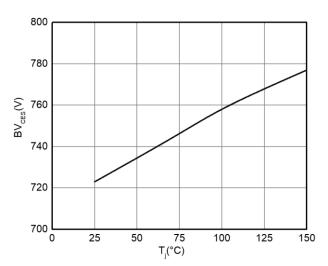


Figure 9. BV as a function of junction temperature ( $I_{CE}$ =250uA)

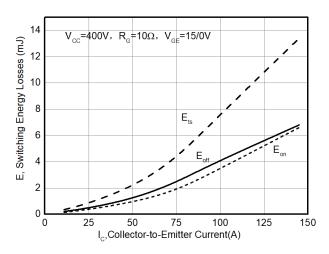


Figure 11.  $E_{on}$ ,  $E_{off}$  as a function of IC  $(T_{i}=25^{\circ}C)$ 

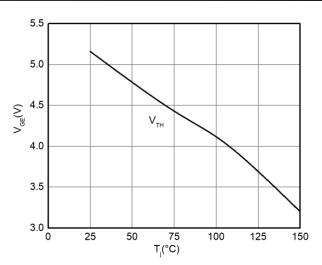


Figure 8.  $V_{TH}$  as a function of junction temperature ( $I_{CF}$ =250uA)

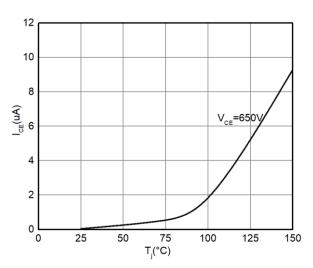


Figure 10. I<sub>CES</sub> leakage current as a function of junction temperature

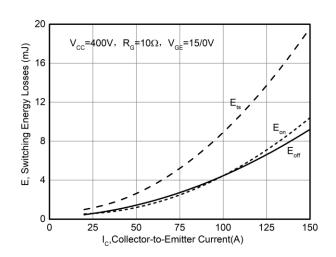


Figure 12.  $E_{on}$ ,  $E_{off}$  as a function of IC  $(T_{j}=150^{\circ}\text{C})$ 



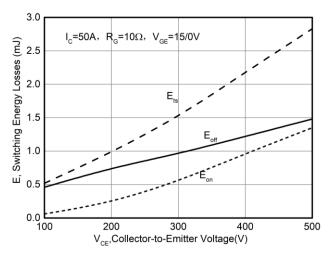


Figure 13.  $E_{on}$ ,  $E_{off}$  as a function of  $V_{CE}$   $(T_i=25^{\circ}C)$ 

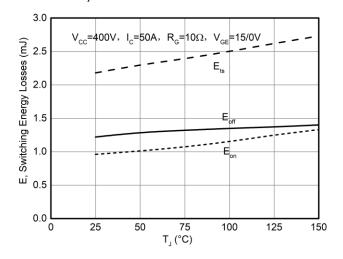


Figure 15.  $E_{on}$ ,  $E_{off}$  as a function of  $T_J$ 

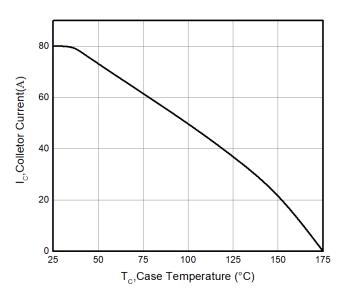


Figure 17. Collector current as a function of case temperature ( $V_{GE} \ge 15V$ ,  $T_j \le 175$ °C)

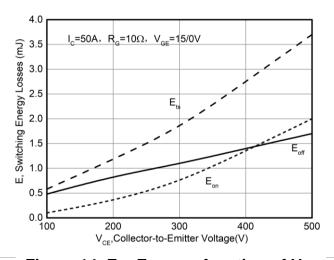


Figure 14.  $E_{on}$ ,  $E_{off}$  as a function of  $V_{CE}$  ( $T_i$ =150°C)

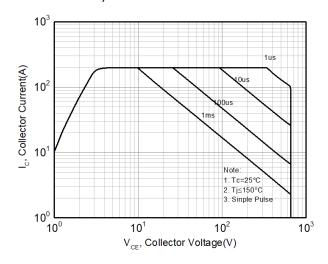
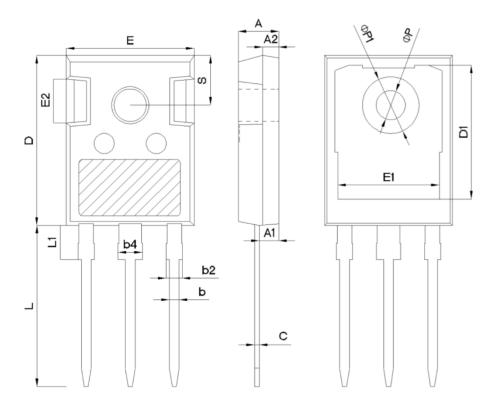


Figure 16. FBSOA

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# TO-247



			1
		mm	
SYMBOL	MIN	NOM	MAX
A	4.80	5.00	5.20
A1	2.21	2.41	2.61
A2	1.85	2.00	2.15
b	1.11	1.21	1.36
b2	1.91	2.01	2.21
b4	2.91	3.01	3.21
С	0.51	0.61	0.75
D	20.70	21.00	21.30
D1	16.25	16.55	16.85
Е	15.50	15.80	16.10
E1	13.00	13.30	13.60
E2	4.80	5.00	5.20
E3	2.30	2.50	2.70
e		5.44BSC	
L	19.62	19.92	20.22
L1	-	-	4.30
ФР	3.40	3.60	3.80
ФР1	-	-	7.30
S		6.15BSC	



# **Revision History:**

Revision	Date	Subjects (major changes since last revision)
1.0	2022-03	Initial Version
1.1	2022-06	Data supplement



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